

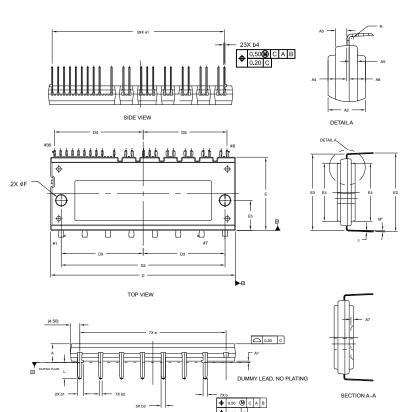


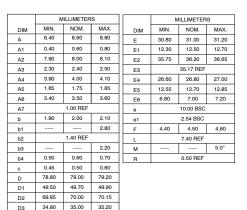
## MOD49 79.00 x 31.00 x 8.00, 10.00P CASE MODGR ISSUE B

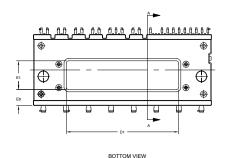
**DATE 10 JAN 2025** 

## NOTES:

- DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2018
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION b and c APPLY TO THE PLATED LEADS AND ARE MEASURED BETWEEN 1.00 AND 2.00 FROM THE LEAD TIP.
- 4. POSITION OF THE LEAD IS DETERMINED AT THE ROOT OF THE LEAD WHERE IT EXITS THE PACKAGE BODY.







37.60

D4

37.80

38.00

## GENERIC MARKING DIAGRAM\*

SIDE VIEW



XXXX = Specific Device Code

ZZZ = Assembly Lot Code

AT = Assembly & Test Location

Y = Year

W = Work Week

NNN = Serial Number

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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